3.3V ECL \div 2, \div 4/6 Clock **Generation Chip**

The MC100LVEL38 is a low skew ÷2, ÷4/6 clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The device can be driven by either a differential or single-ended input signal.

The common enable (\overline{EN}) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip-flop is clocked on the falling edge of the input clock, therefore, all associated specification limits are referenced to the negative edge of the clock input.

The Phase_Out output will go HIGH for one clock cycle whenever the $\div 2$ and the $\div 4/6$ outputs are both transitioning from a LOW to a HIGH. This output allows for clock synchronization within the system.

Upon startup, the internal flip-flops will attain a random state; therefore, for systems which utilize multiple LVEL38s, the master reset (MR) input must be asserted to ensure synchronization. For systems which only use one LVEL38, the MR pin need not be exercised as the internal divider design ensures synchronization between the ÷2 and the ÷4/6 outputs of a single device.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

- 50 ps Maximum Output-to-Output Skew
- Synchronous Enable/Disable
- Master Reset for Synchronization
- ESD Protection: >2 KV HBM
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V_{CC}= 3.0 V to 3.8 V with $V_{EE} = 0 V$
- NECL Mode Operating Range: V_{CC}= 0 V with V_{EE} = -3.0 V to -3.8 V
- Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 388 devices

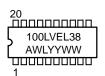


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MARKING DIAGRAM





SO-20 **DW SUFFIX CASE 751D**

= Assembly Location

WL = Wafer Lot

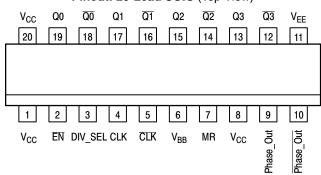
YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC100LVEL38DW	SOIC-20	38 Units/Rail
MC100LVEL38DWR2	SOIC-20	1000 Units/Reel

Pinout: 20-Lead SOIC (Top View)



Warning: All $\rm V_{CC}$ and $\rm V_{EE}$ pins must be externally connected to Power Supply to guarantee proper operation.

FUNCTION TABLE

CLK	ĒN	MR	FUNCTION
Z	L	LLΗ	Divide
ZZ	H		Hold Q ₀₋₃
X	X		Reset Q ₀₋₃

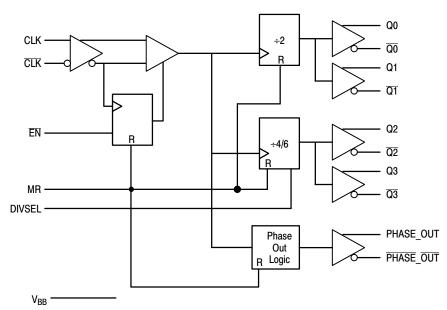
Z = Low-to-High Transition ZZ = High-to-Low Transition X = Don't Care

DIVSEL	${f Q}_2, {f Q}_3$ outputs
L	Divide by 4
H	Divide by 6

PIN DESCRIPTION

PIN	FUNCTION
$\begin{array}{c} \text{CLK,} \overline{\text{CLK}} \\ \text{Q}_0, \text{Q}_1; \overline{\text{Q}_0}, \overline{\text{Q}_1} \\ \text{Q}_2, \text{Q}_3; \overline{\text{Q}_2}, \overline{\text{Q}_3} \\ \text{EN} \\ \text{MR} \\ \text{DIVSEL} \\ \text{Phase_Out,} \overline{\text{Phase_Out}} \\ \text{V}_{\text{BB}} \\ \text{V}_{\text{CC}} \\ \text{V}_{\text{EE}} \end{array}$	ECL Diff Clock Inputs ECL Diff ÷2 Outputs ECL Diff ÷4/6 Outputs ECL Sync Enable Input ECL Master Reset Input ECL Frequency Select Input ECL Phase Sync Diff. Signal Output Reference Voltage Output Positive Supply Negative Supply

LOGIC DIAGRAM



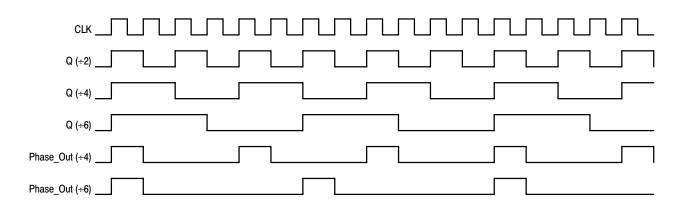


Figure 1. Timing Diagrams

MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		–8 to 0	V
Vi	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{aligned} & V_{I} \leq V_{CC} \\ & V_{I} \geq V_{EE} \end{aligned}$	6 to 0 -6 to 0	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
TA	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	20 SOIC 20 SOIC	90 60	°C/W
θ_{JC}	Thermal Resistance (Junction to Case)	std bd	20 SOIC	30 to 35	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

^{1.} Maximum Ratings are those values beyond which device damage may occur.

LVPECL DC CHARACTERISTICS V_{CC}= 3.3 V; V_{EE}= 0.0 V (Note 1)

		–40°C		25°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		50	60		50	60		54	65	mA
V _{OH}	Output HIGH Voltage (Note 2.)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V _{OL}	Output LOW Voltage (Note 2.)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V _{IH}	Input HIGH Voltage (Single Ended)	2135		2420	2135		2420	2135		2420	mV
V _{IL}	Input LOW Voltage (Single Ended)	1490		1825	1490		1825	1490		1825	mV
V _{BB}	Output Voltage Reference	1.92		2.04	1.92		2.04	1.92		2.04	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 3.)	1.65		2.75	1.65		2.75	1.65		2.75	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 1. Input and output parameters vary 1:1 with V_{CC}. $\dot{\text{V}}_{\text{EE}}$ can vary ± 0.3 V.
- 2. Outputs are terminated through a 50 ohm resistor to $V_{\mbox{CC}}$ -2 volts.
- 3. V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP Min} and 1.0 V.

LVNECL DC CHARACTERISTICS V_{CC} = 0.0 V; V_{EE} = -3.3 V (Note 1.)

			–40°C 25°C								
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		50	60		50	60		54	65	mA
V _{OH}	Output HIGH Voltage (Note 2.)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V _{OL}	Output LOW Voltage (Note 2.)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V _{IH}	Input HIGH Voltage (Single Ended)	-1165		-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single Ended)	-1810		-1475	-1810		-1475	-1810		-1475	mV
V _{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 3.)	-1.65		-0.55	-1.65		-0.55	-1.65		-0.55	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5			0.5			0.5			μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- 1. Input and output parameters vary 1:1 with V_{CC}. $\dot{\text{V}}_{\text{EE}}$ can vary ± 0.3 V.
- Outputs are terminated through a 50 ohm resistor to V_{CC}-2 volts.
 V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP Min} and 1.0 V.

AC CHARACTERISTICS V_{CC} = 3.3 V; V_{EE} = 0.0 V or V_{CC} = 0.0 V; V_{EE} = -3.3 V (Note 1.)

			–40°C		25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Toggle Frequency		TBD			TBD			TBD		GHz
t _{PLH} t _{PHL}	Propagation Delay CLK to Q (Diff) to Output CLK to Q (S.E.) CLK to Phase_Out (Diff) CLK to Phase_Out (S.E.) MR to.Q	760 710 800 750 510		960 1010 1000 1050 810	800 750 840 790 540		1000 1050 1040 1090 840	850 800 890 840 570		1050 1100 1090 1140 870	ps
t _{SKEW}	Within-Device Skew (Note 2.) $Q_0 - Q_3$ All			50 75			50 75			50 75	ps
	$\begin{array}{ccc} \text{Part-to-Part} & & Q_0 - Q_3 \text{ (Diff)} \\ & & \text{All} \end{array}$			200 240			200 240			200 240	
t _{JITTER}	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t _S	Setup Time EN to CLK DIVSEL to CLK		150			150			150		ps
t _H	Hold Time CLK to EN		150 200			150 200			150 200		ps
V _{PP}	Input Swing (Note 3.) CLK	250		1000	250		1000	250		1000	mV
t _{RR}	Reset Recovery Time			100			100			100	ps
t _{PW}	Minimum Pulse Width CLK MR	800 700			800 700			800 700			ps
t _r , t _f	Output Rise/Fall Times Q (20% – 80%)	280		550	280		550	280		550	ps

- 1. V_{EE} can vary ±0.3 V.
- 2. Skew is measured between outputs under identical transitions.
- 3. V_{PP}(min) is minimum input swing for which AC parameters are guaranteed. The device will function reliably with differential inputs down to 100 mV.

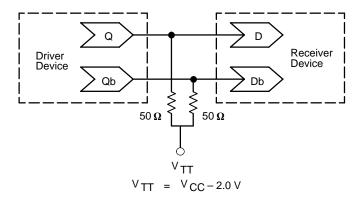


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

Resource Reference of Application Notes

AN1404 – ECLinPS Circuit Performance at Non–Standard V_{IH} Levels

AN1405 – ECL Clock Distribution Techniques

AN1406 – Designing with PECL (ECL at +5.0 V)

AN1503 - ECLinPS I/O SPICE Modeling Kit

AN1504 – Metastability and the ECLinPS Family

AN1560 – Low Voltage ECLinPS SPICE Modeling Kit

AN1568 – Interfacing Between LVDS and ECL

AN1596 – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit

AN1650 – Using Wire-OR Ties in ECLinPS Designs

AN1672 – The ECL Translator Guide

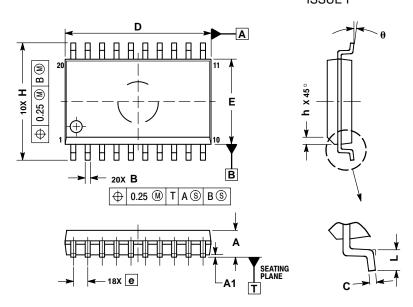
AND8001 – Odd Number Counters Design

AND8002 – Marking and Date Codes

AND8020 – Termination of ECL Logic Devices

PACKAGE DIMENSIONS

SOIC-20 **DW SUFFIX** PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



- NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS									
DIM	MIN	MAX								
Α	2.35	2.65								
A1	0.10	0.25								
В	0.35	0.49								
С	0.23	0.32								
D	12.65	12.95								
E	7.40	7.60								
е	1.27	BSC								
Н	10.05	10.55								
h	0.25	0.75								
L	0.50	0.90								
θ	0 °	7 °								

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